EVERLIGHT EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

1.6mm Round Subminiature Chip LED

26-21/BHC-ATW/CT

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.-
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 26-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Revision

Device Selection Guide

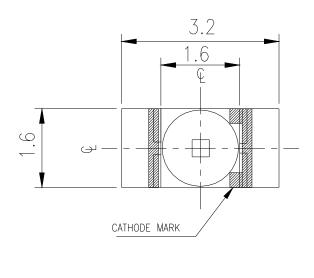
Part No.	Chip	Emitted Color	Resin Color	
Tart No.	Material	Ellitted Color		
26-21/BHC-ATW/CT	InGaN	Blue	Water Clear	

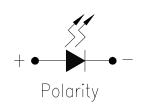


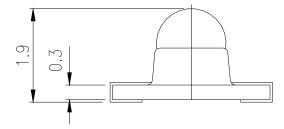
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 1 of 10

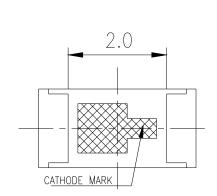
Device No.: SZDSE-261-B08 Prepared date: 04-April-2007 Prepared by:Xiaoyan Release Date: 2008-09-20 00:16:12.0 : 1

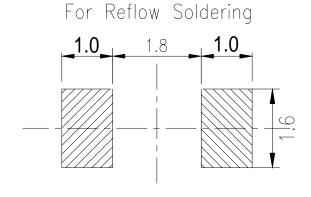
Package Outline Dimensions











Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Device No.: SZDSE-261-B08

Revision : 1

LifecyclePhase:正式發行

http://www.everlight.com

Prepared date: 04-April-2007

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Rev. 1 Page: 2 of 10

Expired Period: Forever



Absolute Maximum Ratings (Ta=25

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	IF	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA
Power Dissipation	Pd	110	mW
Electrostatic Discharge(HBM)	ESD	150	V
Operating Temperature	Topr	-40 ~ +85	
Storage Temperature	Tstg	-40 ~ +90	
Soldering Temperature	Tsol	Reflow Soldering : 260 Hand Soldering : 350	for 10 sec.

Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	285	<u> </u>	1800	mcd	
Viewing Angle	2 1/2	7	30	12	deg	
Peak Wavelength	р	14-1	468		nm	
Dominant Wavelength	d	464.5		476.5	nm	I _F =20mA
Spectrum Radiation Bandwidth			35		nm	
Forward Voltage	VF	2.7	3.3	3.7	V	
Reverse Current	Ir			50	μA	V _R =5V

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 3 of 10

Device No. : SZDSE-261-B08 Prepared date: 04-April-2007 Prepared by:Xiaoyan

Revision : 1 Release Date: 2008-09-20 00:16:12.0



Bin Range Of Dom. Wavelength

Groups	Bin	Min	Max	Unit	Condition
A	A9	464.5	467.5		IF=20mA
	A10	467.5	470.5		
	A11	470.5	473.5	nm	
	A12	473.5	476.5		

Bin Range Of Luminous Intensity

	J			
Bin	Min	Max	Unit	Condition
T	285	450		
U	450	715	mcd	IF=20mA
V	715	1120		
W	1120	1800		

Notes:

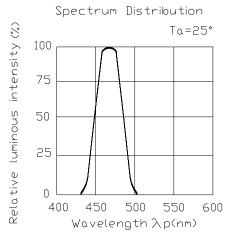
- 1.Tolerance of Luminous Intensity ±11%
- 2. Tolerance of Dominant Wavelength ±1nm

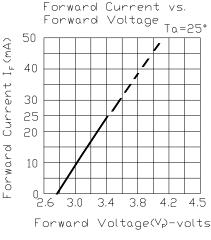
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 4 of 10 Device No.: SZDSE-261-B08 Prepared date: 04-April-2007 Prepared by:Xiaoyan

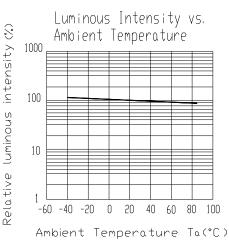
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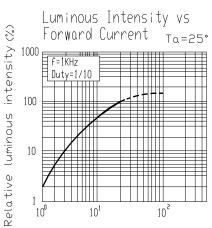
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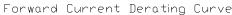
Typical Electro-Optical Characteristics Curves

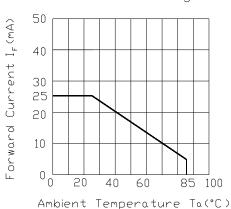


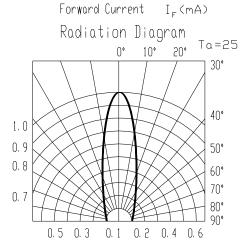












Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 5 of 10

Device No. : SZDSE-261-B08 Prepared date: 04-April-2007 Prepared by:Xiaoyan

Revision : 1 Release Date: 2008-09-20 00:16:12.0

Label explanation

CAT: Luminous Intensity Rank

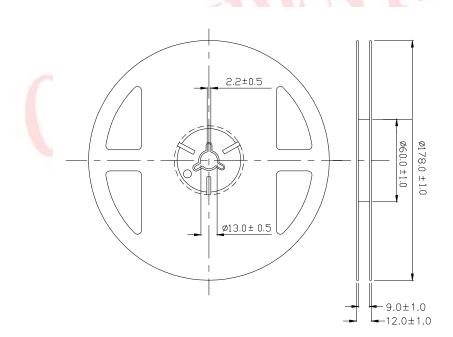
HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Rev. 1 Page: 6 of 10

Reel Dimensions

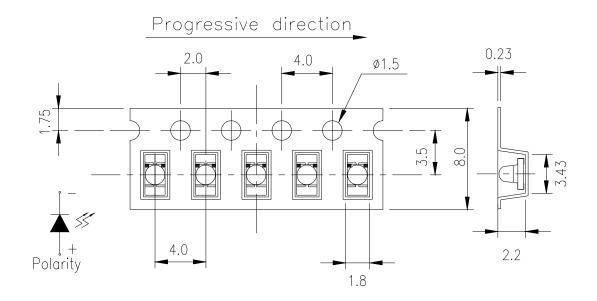


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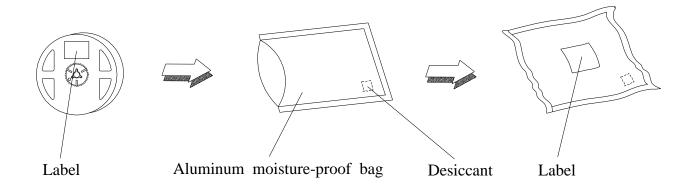
Device No. : SZDSE-261-B08 Prepared date: 04-April-2007 Prepared by:Xiaoyan Revision : 1 Release Date: 2008-09-20 00:16:12.0

Carrier Tape Dimensions: Loaded quantity 1500 PCS per reel



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Moisture Resistant Packaging



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: 1

Revision

Device No.: SZDSE-261-B08 Prepared date

Prepared date: 04-April-2007 Prepared by:Xiaoyan Release Date:2008-09-20 00:16:12.0

Rev. 1 Page: 7 of 10

LifecyclePhase:正式發行 Expired Period: Forever

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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.: 260 ±5 Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100 15min 5 min L: -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100 5min 10 sec L: -10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp.: 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	Hig <mark>h</mark> Temperature / High Humidity	85 / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 8 of 10 Device No.: SZDSE-261-B08 Prepared date: 04-April-2007 Prepared by:Xiaoyan

Device No. : SZDSE-261-B08 Prepared date: 04-April-2007 Prepared by:Xiaoyan

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Precautions For Use

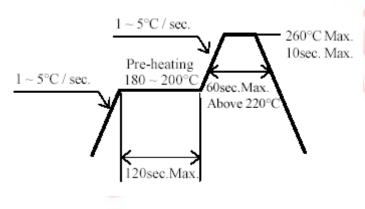
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5 for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

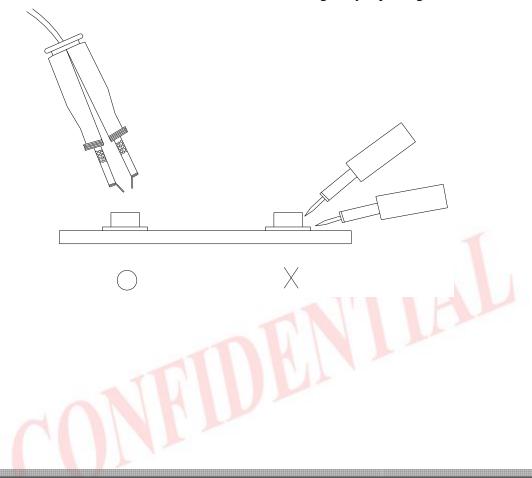
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 9 of 10

Device No.: SZDSE-261-B08 Prepared date: 04-April-2007 Prepared by:Xiaoyan Revision : 1 Release Date: 2008-09-20 00:16:12.0



5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

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Revision : 1 Release Date:2008-09-20 00:16:12.0